

1100V Super-junction Power MOSFET

Description

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Super-junction power MOSFET is a revolutionary technology for high voltage power MOSFETs, designed according to the SJ principle. The deep trench SJ MOSFET provide an extremely low switching, communication and conduction losses device with highest robustness make especially resonant switching applications more reliable, more efficient, lighter and cooler, designed by Wuxi Unigroup Microelectronics Company.

 Features Very low FOM R_{DS(on)}×Q_g 100% avalanche tested Easy to use/drive RoHS compliant 		 Applications Switch Mode Power Supply (SMPS) Uninterruptible Power Supply (UPS) Power Factor Correction (PFC) Low Power Chargers and Adapters 				
TO-220F Drain Gate Gate Source						
Device Marking and Pa	Package		Marking			
TPA110R550A	TO-220F		110R550A			
Key Performance Par	ameters					
Parameter	Value		Unit			
V _{DS} @ T _{j,max}	1150		V			
R _{DS(on),max}	0.55		Ω			
Q _{g,typ}	59		nC			
I _D	12		A			
I _{D,pulse}	36		A			



Absolute Maximum Ratings $T_c = 25^{\circ}C$, unless otherwise noted							
Parameter			Symbol	Values	Unit		
Continuous Drain Current	T _C = 25°C			12	Α		
	T _C = 100°C		Ι _D	7.2			
Pulsed Drain Current (n		(note1)	I _{D,pulse}	36	А		
Gate-Source Voltage			V _{GSS}	±30V	V		
Single Pulse Avalanche Energy		note2)	E _{AS}	80	mJ		
Repetitive Avalanche Energy		note2)	E _{AR}	0.97	mJ		
Avalanche Current			I _{AR}	4	Α		
MOSFET dv/dt Ruggedness, V _{DS} = 0480V			dv/dt	50	V/ns		
Power Dissipation For TO-220F			P _D	34	W		
Continuous Diode Forward Current			۱ _S	12			
Diode Pulsed Current		(note1)	I _{S,pulse}	36	A		
Reverse Diode dv/dt		(note3)	dv/dt	5	V/ns		
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55~+150	°C		

Thermal Resistance For TO-220F						
Parameter	Symbol	Value	Unit			
Thermal Resistance, Junction-to-Case	R _{thJC}	3.67	°C/W			
Thermal Resistance, Junction-to-Ambient	R _{thJA}	80	-0/00			



Electrical Characteristics	T _J = 25°C,	unless otherwise noted					
Demonster			Value				
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	lax.	
Static Characteristics							
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V_{GS} = 0V, I _D = 250µA	1100			V	
		V_{DS} =1100V, V_{GS} = 0V, T_{J} = 25°C			1	μA	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 1100V, V _{GS} = 0V, T _J = 150°C			100		
Gate-Source Leakage Current	I _{GSS}	$V_{GS} = \pm 30V$			±100	nA	
Gate-Source Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	2.5		4.5	V	
Drain-Source On-State-Resistance	R _{DS(on)}	V_{GS} = 10V, I_{D} = 4A		0.41	0.55	Ω	
Dynamic Characteristics				•	•		
Input Capacitance	C _{iss}	V _{GS} = 0V,		2562		pF	
Output Capacitance	C _{oss}	V _{DS} = 100V,		68			
Reverse Transfer Capacitance	C _{rss}	f = 1.0MHz		2.6			
Total Gate Charge	Qg			59		nC	
Gate-Source Charge	Q _{gs}	$V_{DD} = 400V, I_D = 4A, V_{GS} = 10V$		14			
Gate-Drain Charge	Q _{gd}			22			
Turn-on Delay Time	t _{d(on)}			51			
Turn-on Rise Time	t _r	V _{DD} = 400V, I _D = 20A,		73		ns .	
Turn-off Delay Time	t _{d(off)}	R _G = 25Ω		155			
Turn-off Fall Time	t _f			66			
Drain-Source Body Diode Characte	ristics						
Body Diode Forward Voltage	V_{SD}	$T_{J} = 25^{\circ}C, I_{SD} = 4A, V_{GS} = 0V$		0.78	1.2	V	
Reverse Recovery Time	t _{rr}			677		ns	
Reverse Recovery Charge	Q _{rr}	V _R = 520V, I _F = I _S , di _F /dt = 100A/µs		9		μC	
Peak Reverse Recovery Current	I _{rrm}			25		А	

Notes

- 1. Repetitive Rating: Pulse width limited by maximum junction temperature
- 2. I_D = 10A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 3. Identical low side and high side switch with identical ${\sf R}_{\sf G}$



Typical Characteristics $T_J = 25^{\circ}C$, unless otherwise noted

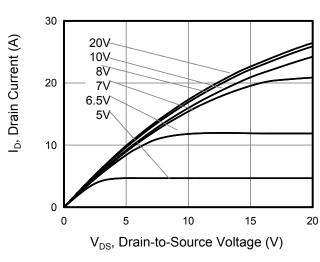
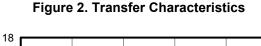


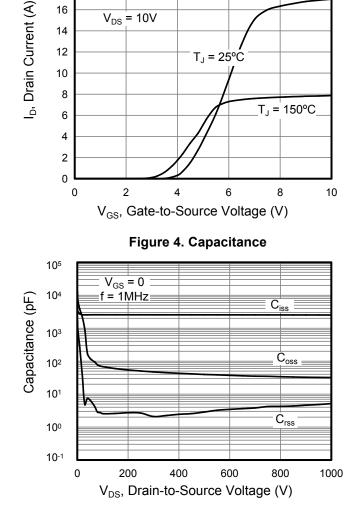
Figure 1. Output Characteristics



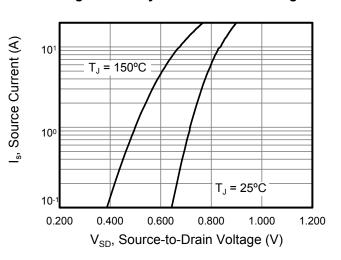
 $V_{DS} = 10V$

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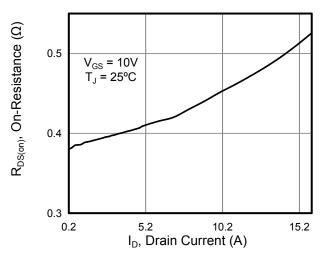
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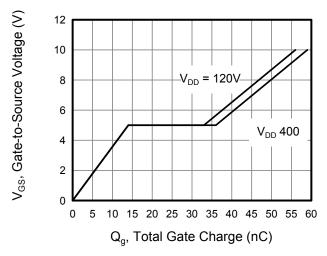




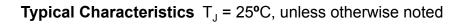


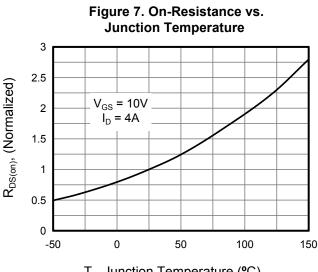




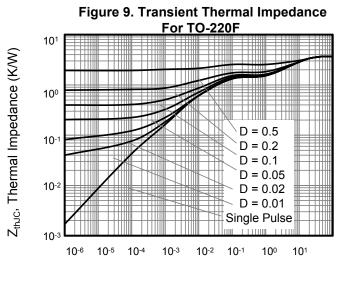




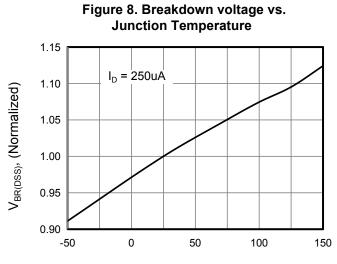




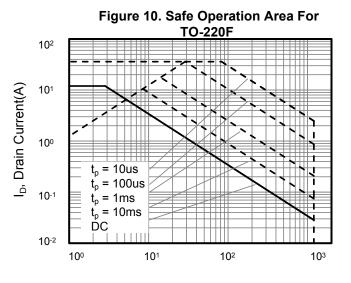
T_J, Junction Temperature (°C)



 T_p , Pulse Width (s)



T_J, Junction Temperature (°C)



V_{DS}, Drain-Source Voltage(V)



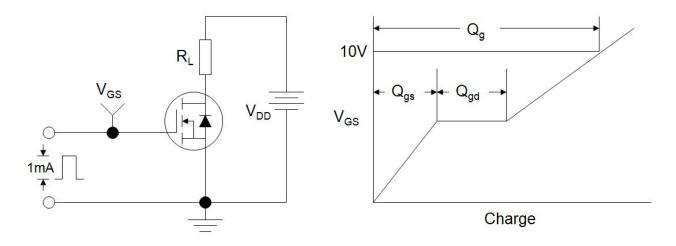


Figure B: Resistive Switching Test Circuit and Waveform

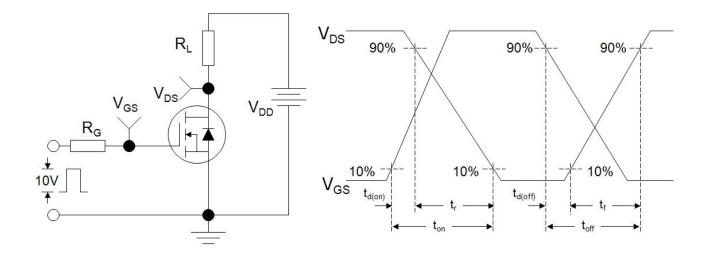
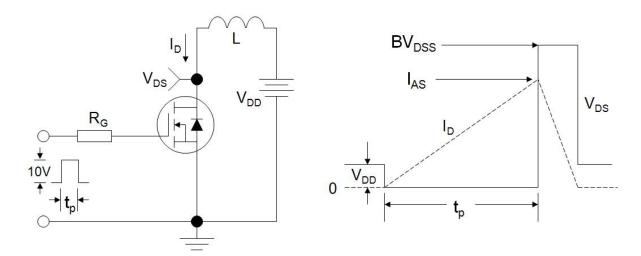
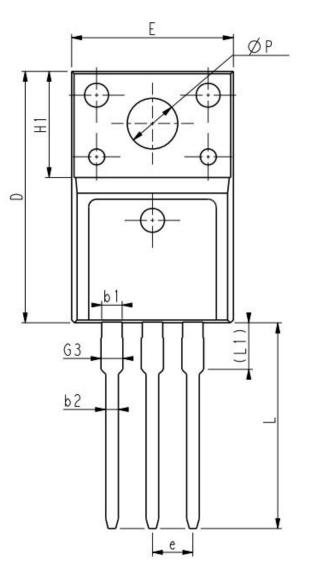
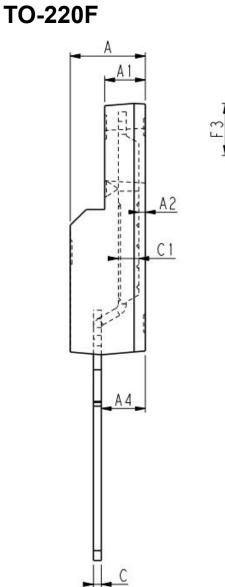


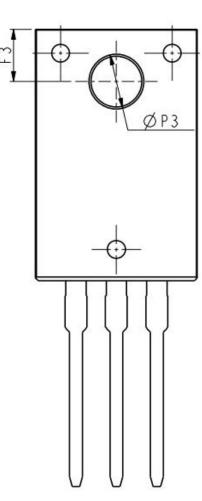
Figure C: Unclamped Inductive Switching Test Circuit and Waveform











Unit:mm			Unit:mm				
Symbol	Min.	Nom	Max.	Symbol	Min.	Max.	
E	9.96	10.16	10.36	е	2.54BSC		
А	4.50	4.70	4.90	L	12.68	12.98	13.28
A1	2.34	2.54	2.74	L1	2.93	3.03	3.13
A2	0.30	0.45	0.60	ΦΡ	3.03	3.18	3.38
A4	2.56	2.76	2.96	ΦΡ3	3.15	3.45	3.65
С	0.40	0.50	0.65	F3	3.15	3.30	3.45
c1	1.20	1.30	1.35	G3	1.25	1.35	1.55
D	15.57	15.87	16.17	b1	1.18	1.28	1.43
H1		6.70REF		b2	b2 0.70 0.80		

V1.0



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